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Texas Instruments SN65LVDS84AQDGGRQ1

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SN65LVDS84AQ-Q1

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SLLS766A-AUGUST 2006-REVISED APRIL 2008

FEATURES

- 21:3 Data Channel Compression at up to 196 Mbytes/s Throughput
- Suited for SVGA, XGA, or SXGA Data **Transmission From Controller to Display With** Very Low EMI
- 21 Data Channels Plus Clock In Low-Voltage **TTL Inputs and 3 Data Channels Plus Clock Out Low-Voltage Differential Signaling (LVDS)** Outputs
- **Operates From a Single 3.3-V Supply and** 89 mW (Typ)
- Packaged in Thin Shrink Small-Outline Package (TSSOP) With 20-Mil Terminal Pitch
- Consumes Less Than 0.54 mW When Disabled
- Wide Phase-Lock Input Frequency Range: 31 MHz to 75 MHz
- No External Components Required for PLL
- **Outputs Meet or Exceed the Requirements of** ANSI EIA/TIA-644 Standard
- SSC Tracking Capability of 3% Center Spread at 50-kHz Modulation Frequency
- Improved Replacement for SN75LVDS84 and NSC DS90CF363A 3-V Device
- **Qualified for Automotive Applications**

(TOP VIEW)								
D4 [1	48] D3					
V _{cc} [2	47] D2					
D5 [3	46] GND					
D6 [4	45] D1					
GND [5	44] D0					
D7 [6	43] NC					
D8 [7	42	LVDSGND					
V _{CC} [8	41] YOM					
D9 [9	40] Y0P					
D10 [10	39] Y1M					
GND [11	38] Y1P					
D11 [12	37	LVDSV _{CC}					
D12 [13	36	LVDSGND					
NC [14	35] Y2M					
D13 [15	34] Y2P					
D14 [16	33	CLKOUTM					
GND [17	32	CLKOUTP					
D15 [18	31	LVDSGND					
D16 [19	30] PLLGND					
D17 [20	29] PLLV _{CC}					
V _{cc} [21	28] PLLGND					
D18 [22	27	<u>] SHTDN</u>					
D19 [23	26] CLKIN					
GND [24	25] D20					

DGG PACKAGE

NC - Not Connected

DESCRIPTION/ORDERING INFORMATION

The SN65LVDS84AQ FlatLink™ transmitter contains three 7-bit parallel-load serial-out shift registers, and four low-voltage differential signaling (LVDS) line drivers in a single integrated circuit. These functions allow 21 bits of single-ended LVTTL data to be synchronously transmitted over 3 balanced-pair conductors for receipt by a compatible receiver, such as the SN75LVDS82 or SN75LVDS86/86A.

When transmitting, data bits D0-D20 are each loaded into registers of the SN65LVDS84AQ upon the falling edge. The internal PLL is frequency-locked to CLKIN and then used to unload the data registers in 7-bit slices. The three serial streams and a phase-locked clock (CLKOUT) are then output to LVDS output drivers. The frequency of CLKOUT is the same as the input clock, CLKIN.

The SN65LVDS84AQ requires no external components and little or no control. The data bus appears the same at the input to the transmitter and output of the receiver with the data transmission transparent to the user(s). The only user intervention is the possible use of the shutdown/clear (SHTDN) active-low input to inhibit the clock and shut off the LVDS output drivers for lower power consumption. A low-level on this signal clears all internal registers to a low level.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet. FlatLink is a trademark of Texas Instruments.



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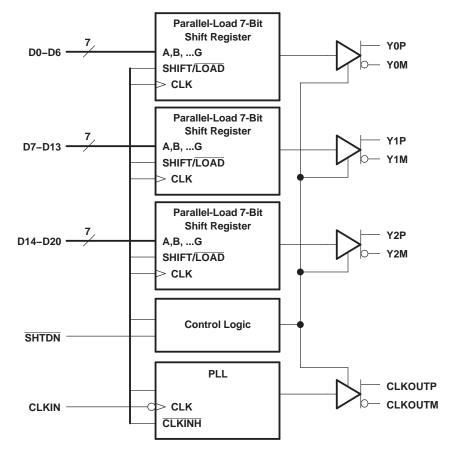
The SN65LVDS84AQ is characterized for operation over the full automotive temperature range of -40° C to 125°C.

ORDERING INFORMATION⁽¹⁾

T _A	PACKAGE ⁽²⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
–40°C to 125°C	TSSOP – DGG	Reel of 2000	SN65LVDS84ADGGRQ1	65LVDS84AQ	

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



FUNCTIONAL BLOCK DIAGRAM

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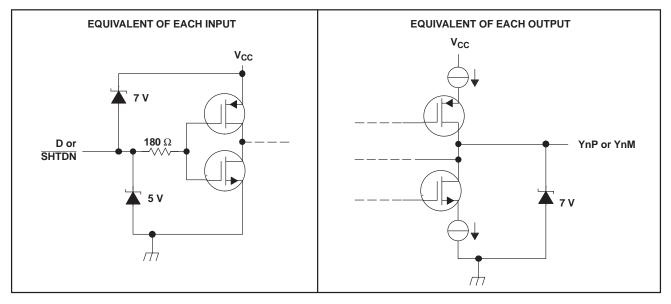


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SCHEMATICS OF INPUT AND OUTPUT

Absolute Maximum Ratings⁽¹⁾⁽²⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{CC}	Supply voltage range		-0.5	4	V
V _O V _I	nput and output voltage range (all terminals)		-0.5	V _{CC} + 0.5	V
	Continuous total power dissipation				ating Table
TJ	Operating virtual junction temperature range	-40	150	°C	
		Machine model		200	V
ESD	Electrostatic discharge rating	Human-body model		6000	V
		Charged-device model		1500	V
T _{stg}	Storage temperature range		-65	150	°C
	Lead temperature 1,6 mm (1/16 in) from case	se for 10 s		260	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values are with respect to the GND terminals.

Dissipation Rating Table

PACKAGE	T _A ≤ 25°C	DERATING FACTOR ⁽¹⁾	T _A = 70°C	T _A = 125°C
	POWER RATING	ABOVE $T_A = 25^{\circ}C$	POWER RATING	POWER RATING
DGG	1637 mW	13.1 mW/°C	1048 mW	327 mW

(1) This is the inverse of the junction-to-ambient thermal resistance when board mounted and with no air flow.



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Recommended Operating Conditions

		MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage	3	3.3	3.6	V
V _{IH}	High-level input voltage	2			V
V _{IL}	Low-level input voltage			0.8	V
ZL	Differential load impedance	90		132	Ω
T _A	Operating free-air temperature	-40		125	°C

Timing Requirements

		MIN	NOM	MAX	UNIT
t _c	Input clock period	13.3	t _c	32.4	ns
tw	Pulse duration, high-level input clock	0.4 t _c		0.6 t _c	ns
tt	Transition time, input signal			5	ns
t _{su}	Setup time, data, D0–D20 valid before CLKIN↓ (see Figure 2)	3			ns
t _h	Hold time, data, D0–D20 valid after CLKIN↓ (see Figure 2)	1.5			ns

Electrical Characteristics

over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDI	TEST CONDITIONS			MAX	UNIT
V _{IT}	Input threshold voltage				1.4		V
V _{OD}	Differential steady-state output voltage magnitude	$R_L = 100 \Omega$, See Figure 3		247		454	mV
Δ V _{OD}	Change in the steady-state differential output voltage magnitude between opposite binary states					50	mV
V _{OC(SS)}	Steady-state common-mode output voltage	$R_L = 100 \Omega$, See Figure 3	3	1.125		1.375	V
V _{OC(PP)}	Peak-to-peak common-mode output voltage				80	150	mV
I _{IH}	High-level input current	$V_{IH} = V_{CC}$				25	μA
IIL	Low-level input current	$V_{IL} = 0$			±10	μA	
1	Chart airquit autput aurrant	$V_{O(Yn)} = 0$		-6	±24	mA	
I _{OS}	Short-circuit output current	$V_{OD} = 0$		-6	±12	mA	
I _{OZ}	High-impedance output current	$V_0 = 0$ to V_{CC}				±10	μA
		Disabled, All inputs at GN	ND		15	170	μA
		Enabled,	f = 65 MHz		27	35	
I _{CC(AVG)}	Quiescent supply current (average)	$R_L = 100 \Omega$ (4 places), Gray-scale pattern (see Figure 4)	f = 75 MHz		30	38	
		Enabled,	f = 65 MHz 28	28	36	mA	
		$R_L = 100 \Omega$ (4 places), Worst-case pattern (see Figure 5)	f = 75 MHz		31	39	
CI	Input capacitance				2		pF

(1) All typical values are at V_{CC} = 3.3 V, T_A = 25° C.

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Switching Characteristics

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	ТҮР ⁽¹⁾ МАХ	UNIT	
t _{d0}	Delay time, CLKOUT↑ to serial bit position 0		-0.2	0.2		
t _{d1}	Delay time, CLKOUT↑ to serial bit position 1		$\frac{1}{7}t_{C}^{}-0.2$	$\frac{1}{7}t_{C} + 0.2$		
t _{d2}	Delay time, CLKOUT↑ to serial bit position 2		$\frac{2}{7}t_{C}^{} - 0.2$	$\frac{2}{7}t_{C} + 0.2$		
t _{d3}	Delay time, CLKOUT↑ to serial bit position 3	$t_c = 15.38$ ns (±0.2%), Input clock jitter < 50 ps ⁽²⁾ , See Figure 6	$\frac{3}{7}t_{C}^{}-0.2$	$\frac{3}{7}t_{C} + 0.2$	ns	
t _{d4}	Delay time, CLKOUT↑ to serial bit position 4		$\frac{4}{7}t_{C}^{}-0.2$	$\frac{4}{7}t_{C} + 0.2$		
t _{d5}	Delay time, CLKOUT↑ to serial bit position 5		$\frac{5}{7}t_{C}^{} - 0.2$	$\frac{5}{7}t_{C} + 0.2$		
t _{d6}	Delay time, CLKOUT↑ to serial bit position 6		$\frac{6}{7}t_{C}^{}-0.2$	$\frac{6}{7}t_{C} + 0.2$		
t _{sk(o)}	Output skew, $t_n - \frac{n}{7}t_c$		-0.2	0.2	ns	
•	Delay time, CLKIN↓ to	t_c = 15.38 ns (±0.2%), Input clock jitter < 50 ps $^{(2)},$ See Figure 6		2.7	20	
t _{d7}	CLKOUT↑	$ \begin{array}{l} t_c = 13.33 \; ns \sim 32.25 \; ns \; (\pm 0.2\%), \\ Input clock jitter < 50 \; ps^{(2)}, \\ See \; Figure \; 6 \end{array} $	1 4.		- ns	
٨٠	Cycle time, output clock	t_c = 15.38 + 0.308 sin(2 π 500E3t) ± 0.05 ns, See Figure 7		±62		
∆t _{c(o)}	jitter ⁽³⁾	t_c = 15.38 + 0.308 sin(2 π 3E6t) ±0.05 ns, See Figure 7		±121	– ps	
t _w	Pulse duration, high-level output clock			$\frac{4}{7}t_{C}$	ns	
tt	Transition time, differential output voltage (t _r or t _f)	See Figure 3		700 1500	ps	
t _{en}	Enable time, SHTDN ↑ to phase lock (Yn valid)	See Figure 8		1	ms	
t _{dis}	Disable time, <u>SHTDN</u> ↓ to off state (CLKOUT low)	See Figure 9		6.5	ns	

(1)

All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$. |Input clock jitter| is the magnitude of the change in the input clock period. Output clock jitter is the change in the output clock period from one cycle to the next cycle observed over 15000 cycles. (2) (3)



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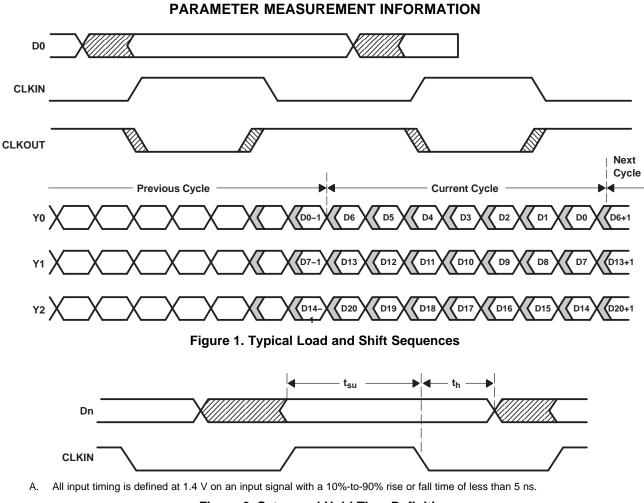


Figure 2. Setup and Hold Time Definition



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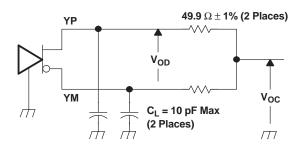
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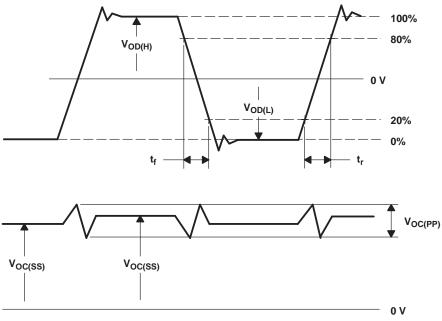
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PARAMETER MEASUREMENT INFORMATION (continued)



NOTE A: The lumped instrumentation capacitance for any single-ended voltage measurement is less than or equal to 10 pF. When making measurements at YP or YM, the complementary output is similarly loaded.
(a) SCHEMATIC



(b) WAVEFORMS

Figure 3. Test Load and Voltage Definitions for LVDS Outputs

Product Folder Link(s): SN65LVDS84AQ-Q1



SN65LVDS84AQ-Q1



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PARAMETER MEASUREMENT INFORMATION (continued)	
D0, 6, 12	
D1, 7, 13	
D2, 8, 14	
D3, 9, 15	
D18, 19, 20	
All others	
 A. The 16-grayscale test-pattern test device power consumption for a typical display pattern. B. V_{IH} = 2 V and V_{IL} = 0.8 V Figure 4. 16-Grayscale Test-Pattern Waveforms 	
↓ t _c →	
Even Dn	
Odd Dn	

A. The worst-case test pattern produces nearly the maximum switching frequency for all of the LVDS outputs.

B. $V_{IH} = 2 V$ and $V_{IL} = 0.8 V$

Figure 5. Worst-Case Test-Pattern Waveforms

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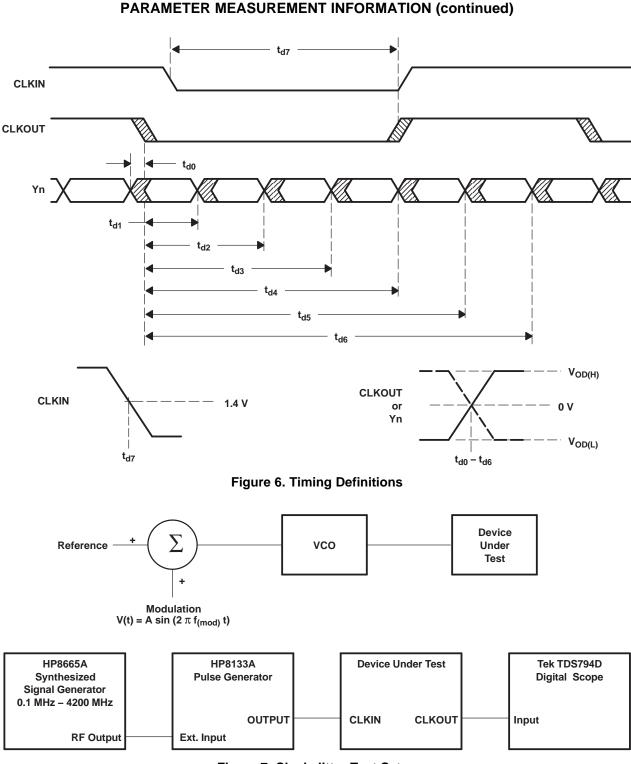


Figure 7. Clock Jitter Test Setup

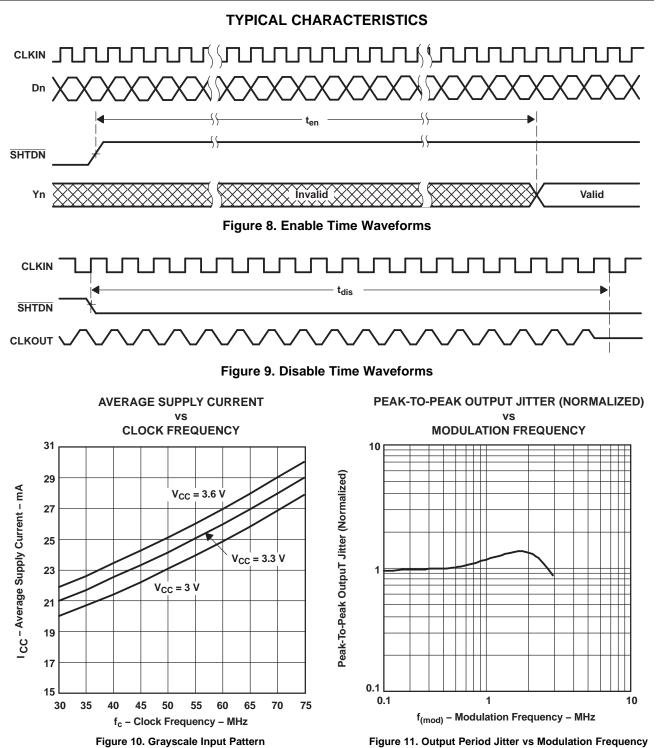


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Host Cable | Flat Panel Display **Graphics Controller** SN75LVDS84A/ SN75LVDS86/86A 12-BIT 18-BIT SN65LVDS84AQ 8 44 41 RED0 D0 RED0 YOM A0M 45 RED1 RED1 D1 47 100 Ω < RED2 RED2 D2 48 40 9 RED3 D3 RED3 Y0P A0P 1 RED4 D4 NΑ 3 NA RED5 D5 4 10 39 GREEN0 **GREEN0** D6 Y1M A1M 6 GREEN1 **GREEN1** D7 7 **1'00** Ω ≶ GREEN2 GREEN2 D8 9 11 38 GREEN3 D9 GREEN3 A1P Y1P 10 GREEN4 D10 NA 12 NA GREEN5 D11 13 35 14 BLUE0 BLUE0 D12 Y2M A2M 15 BLUE1 BLUE1 D13 16 **100** Ω ≥ BLUE2 BLUE2 D14 18 15 34 BLUE3 BLUE3 D15 Y2P A2P 19 BLUE4 D16 NA 20 NA BLUE5 D17 22 16 33 H_SYNC H_SYNC D18 CLKOUTM CLKINM 23 V_SYNC V_SYNC D19 25 **100** Ω ≷ ENABLE ENABLE D20 26 32 17 CLOCK CLOCK CLKIN CLKOUTP CLKINP

APPLICATION INFORMATION

A. The five 100- Ω terminating resistors are recommended to be 0603 types.

 ${\sf B}. \quad {\sf N}{\sf A}-{\sf not} \ {\sf applicable}, \ {\sf these} \ {\sf unused} \ {\sf inputs} \ {\sf should} \ {\sf be} \ {\sf left} \ {\sf open}.$

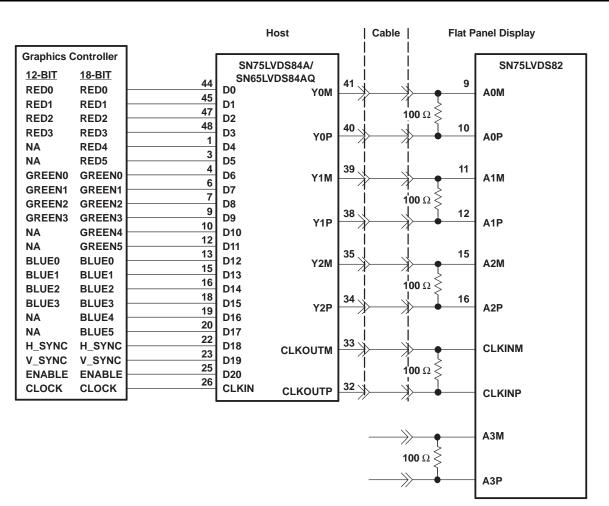
Figure 12. Color Host to LCD Panel Application

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- A. The four 100- Ω terminating resistors are recommended to be 0603 types.
- B. NA not applicable, these unused inputs should be left open.

Figure 13. 18-Bit Color Host to 24-Bit LCD Display Panel Application

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PACKAGE OPTION ADDENDUM

15-Apr-2008

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Pa	ackage Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN65LVDS84AQDGGRQ1	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS &	CU NIPDAU	Level-2-260C-1 YEAR

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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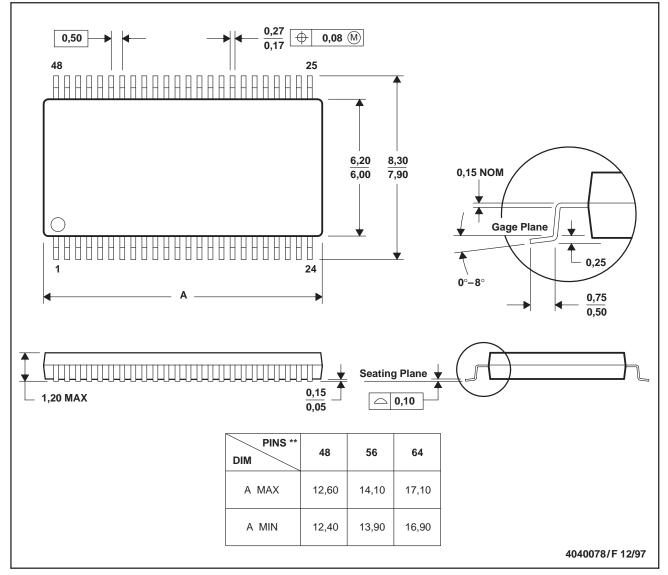
MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153





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